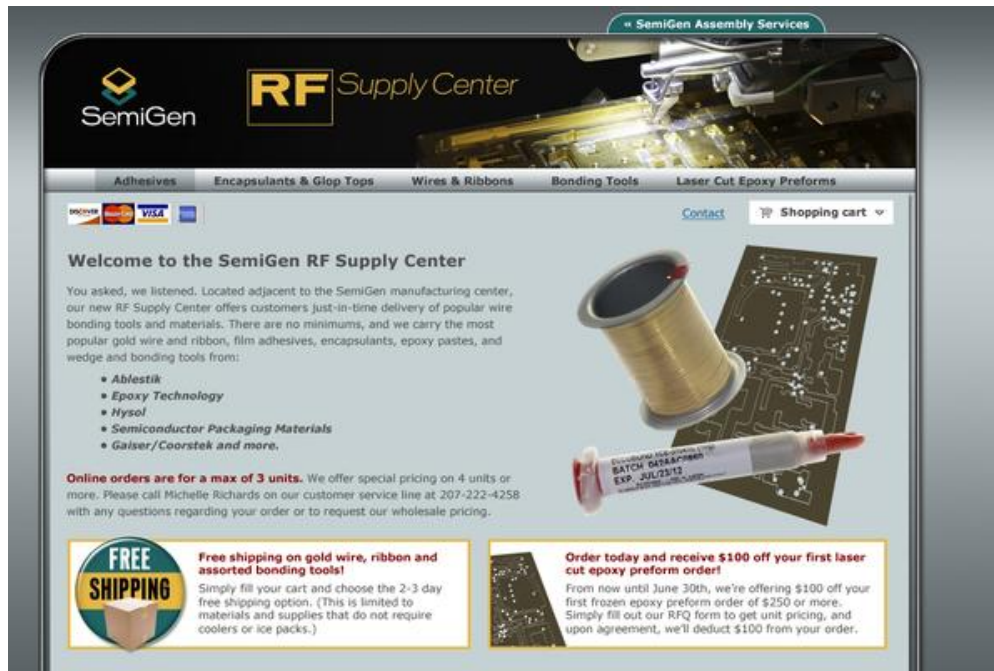


SemiGen to Showcase New RF Supply Center at IMS



In IMS Booth # 301 in

Montreal, Canada next week, SemiGen, Inc., an RF/Microwave assembly and automated PCB manufacturing house, will be showcasing their new RF Supply Center, an online source for bonding supplies, materials, and tools. The center offers immediate shipment of low volumes of popular epoxies, adhesive films, bonding tools, gold wire and other supplies used in die attach, substrate attach, chip bonding, assembly, screen printing, and surface mounting of microwave modules and components. Products include electrically insulating and conductive pastes and films from Ablestik and Epoxy Technology, glob tops, damming material and encapsulants from Hysol, and gold wire, gold ribbon, and silicon-aluminum wire from Semiconductor Packaging Materials. Bonding tools include tungsten wire, unplugging probes, ball bond capillaries, waffle tacking tools, and a variety of wire and ribbon wedge tools from Gaiser/Coorstek. Custom laser cut epoxy preforms from Laser Services are also available. Free shipping is offered for gold wire, ribbon and bonding tools.

www.semigen.net [1]

Posted by Sara Cohen, Editorial Intern

June 18, 2012

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Published on Wireless Design & Development (<http://www.wirelessdesignmag.com>)

Source URL (retrieved on 01/29/2015 - 6:19am):

http://www.wirelessdesignmag.com/news/2012/06/semigen-showcase-new-rf-supply-center-ims?qt-blogs=0&qt-digital_editions=0

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